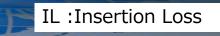
STP cable Analysis of insertion loss degradation in high temperature atmosphere

Taketo Kumada YAZAKI 2018.01.25







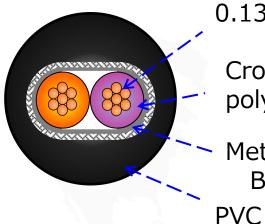
- 1 Contents of indications at the last meeting
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- 3 Comparison of calculated value and measured value
- 4 Calculation of IL
- 5 Comparison of IL between 23°C and 105°C
- 6 IL up to 7.5GHz in 23℃ and 105℃



1 Contents of indications at the last meeting

IL : Insertion Loss

Cable structure



0.13mm² Pure copper

Cross-linked polyethylene

Metal foil + Braided shield

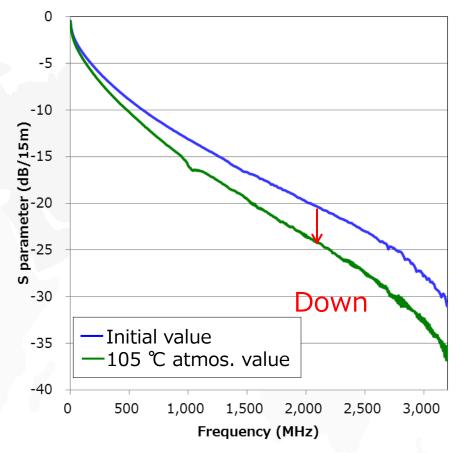
Figure 10: Cable structure

Contents of indications

To explain the reason why the IL remarkably decreases in 105° atmosphere.

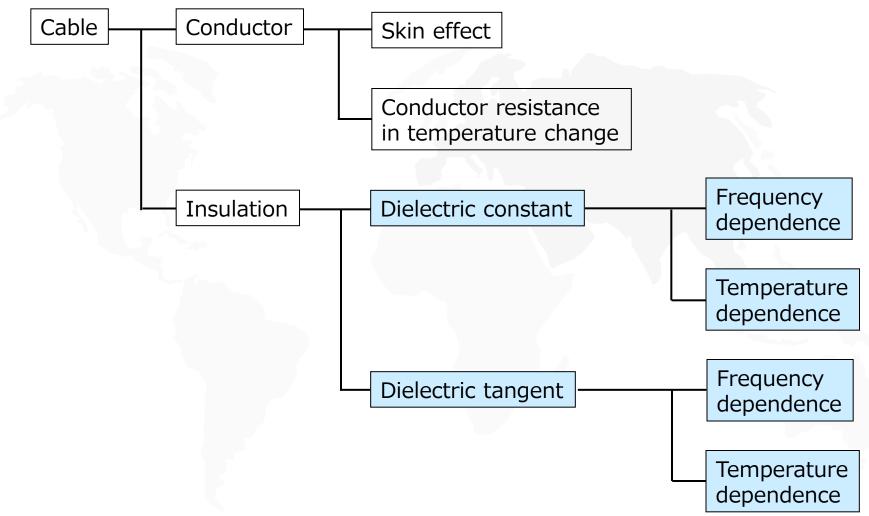
⇒ Based on theoretical formula, the results of actual measurements were verified at this time







Main factors



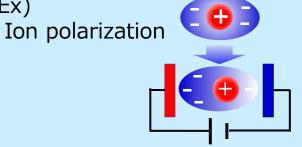


Dielectric constant : The ease of dielectric polarization of a medium filled between electrodes

Ex)

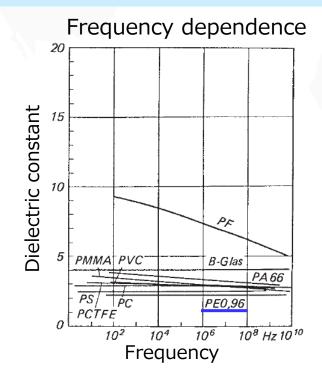
Types of polarization

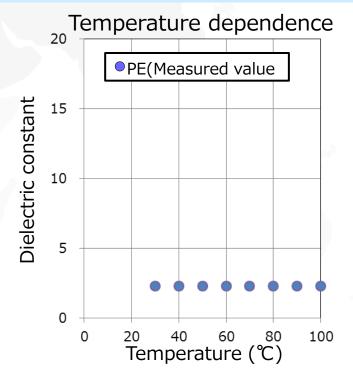
- Electronic polarization
- Ion polarization
- Orientation polarization



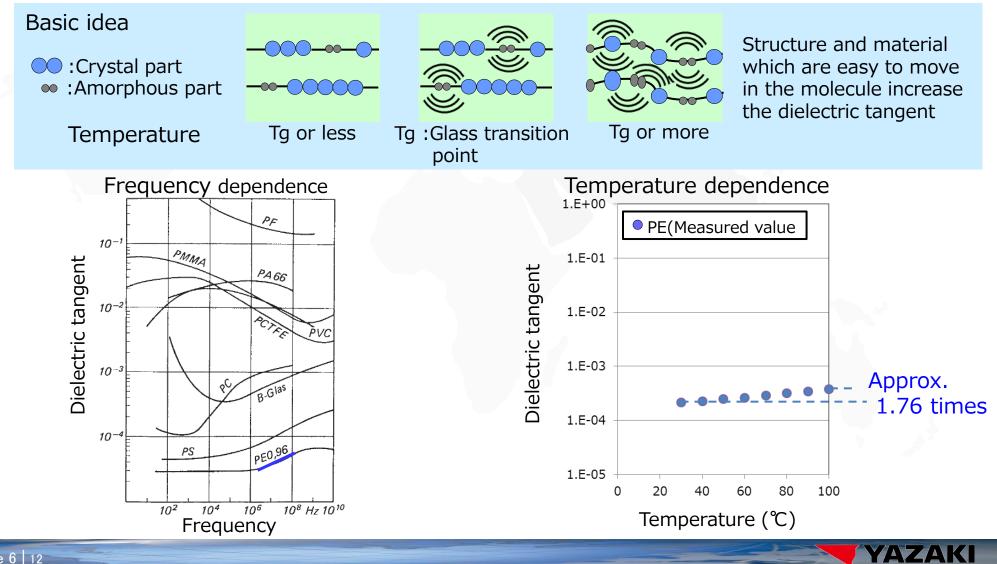
If polarization is large, the bias of electricity in material is large

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Dielectric tangent : Electric energy causes molecular motion, it is lost as thermal energy



3 Comparison of calculated value and measured value

@ 23℃ atmosphere 0 Measured value Calculated value -10 Insertion loss (dB/15m) -20 -30 Influence of -40 suck-out -50 Suck-out -60 1,000 2,000 3,000 4,000 5,000 6,000 7,000 7,500 0 2,200 Frequency (MHz)

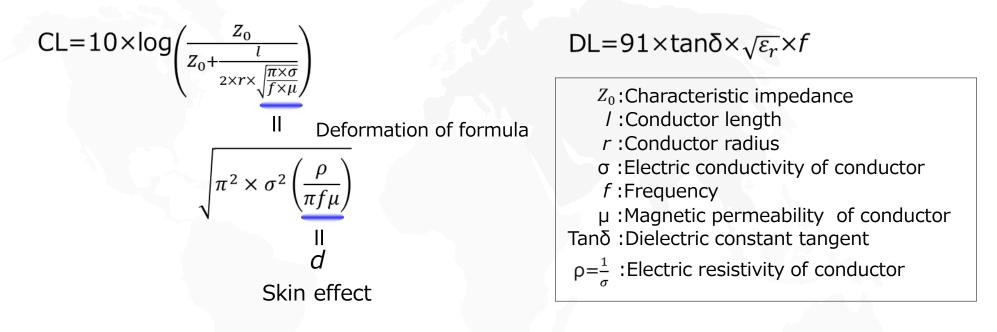
- More than 2.2GHz are affected by suck-out
- Measured value and calculated value match up to 2.2GHz

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4 Calculate IL

Formula of Insertion loss

Insertion loss(IL) = Conductor loss(CL) + Dielectric loss(DL)



i.e. Skin effect is taken into account in CL



4 Calculation of IL

Calculation at 105℃ atmosphere

Conductor resistance in temperature change

 $R = R_0 |1 + \alpha (T - 20)|$

 $R_{23^{\circ}C}$: Conductor resistance at 23°C

 $R_{23^{\circ}C} = R_0 |1 + 0.00393 \times (23 - 20)|$

 $R_{105^{\circ}C}: \text{Conductor resistance at } 105^{\circ}C$ $R_{105^{\circ}C} = R_0 |1 + 0.00393 \times (105 - 20)|$ $\frac{R_{105^{\circ}C}}{R_{23^{\circ}C}} = 1.318 = \beta_{23^{\circ}C \Rightarrow 105^{\circ}C}$

> Temperature dependence of dielectric tangent Temperature dependence 1.E+00 **Dielectric tangent** 1.E-01 1.E-02 1.E-03 Approx. 1.76 times 1.E-04 Influence of structure 1.E-05 0 20 60 80 $=\gamma$ Temperature ($^{\circ}$ C)

Formula of Insertion loss

Insertion loss(IL) = Conductor loss(CL) + Dielectric loss(DL)

 $CL=10 \times \log \left(\frac{Z_0}{Z_0 + \frac{i}{2 \times r \times \sqrt{\frac{\pi \times \sigma / \beta_{23} \circ C \Rightarrow 105 \circ C}{f \times \mu}}} \right)$

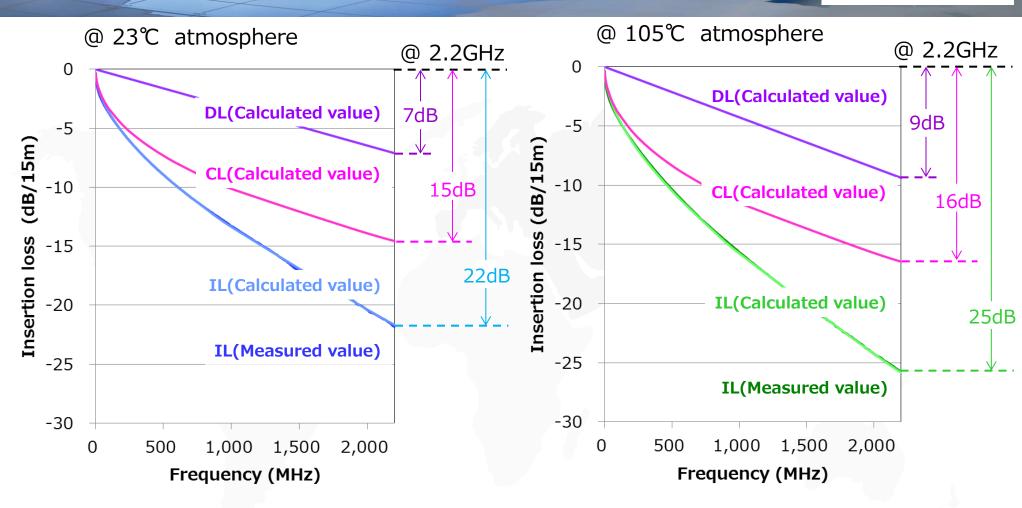
 $\mathsf{DL}=91\times\mathsf{tan}\delta\times\sqrt{\varepsilon_r\times\gamma}\times f$

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However, the theoretical formula of IL used in this study does not consider the twist of the conductor, shielding layer or the frequency dependence of the dielectric tangent, etc.

5 Comparison of IL between 23℃ and 105℃

IL :Insertion Loss CL :Conductor Loss DL :Dielectric Loss

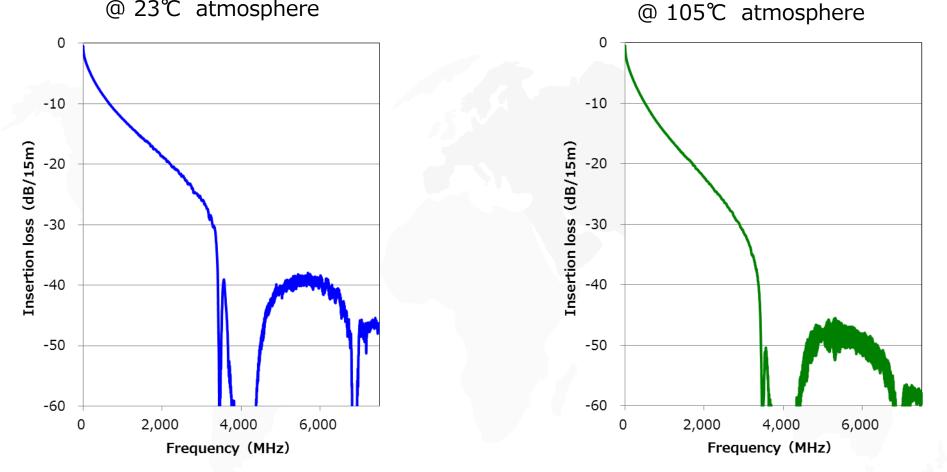


In the case of 105° atmosphere, the influence of DL tends to be large particularly in high frequency band. Therefore the influence of the temperature dependence of the dielectric tangent was also found to be large.



IL up to 7.5GHz in 23℃ and 105℃ 6

@ 23℃ atmosphere



The above data is downloaded in the private area



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END Thank you for your attention

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